Application Data Sheet APPLICATION INFORMATION

Secrecy Order in Parent Appl.?:: No

Application Number::	
Filing Date::	
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD Disks:	
Number of Copies of CDs::	
Sequence Submission?::	
Computer Readable From (CRF)	?:: No
Number of Copies of CRF::	
Title::	SEMICONDUCTOR DEVICE METHOD FOR
	MANUFACTURING THE SAME, APPARATUS
	FOR FORMING FILM, AND METHOD FOR
	FORMING HIGH-DIELECTRIC-CONSTANT FILM
Attorney Docket Number::	403018
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	12
Small Entity?::	No
Latin Name::	
Variety denomination name::	
Petition Included?::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	

Page 1 03/30/04

APPLICANT INFORMATION

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Satoshi

Middle Name::

Family Name:: KAMIYAMA

Name Suffix::

City of Residence:: Ibaraki

Country of Residence:: Japan

Street of mailing address:: c/o Semiconductor Leading Edge

Technologies, Inc.

16-1 Onogawa

City of mailing address:: Tsukuba-shi

State or Province of mailing address:: Ibaraki

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 305-0053

Inventor Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Tsunetoshi

Middle Name::

Family Name:: ARIKADO

Name Suffix::

City of Residence:: Ibaraki

Country of Residence:: Japan

Street of mailing address:: c/o Semiconductor Leading Edge

Technologies, Inc.

16-1 Onogawa

City of mailing address:: Tsukuba-shi

State or Province of mailing address:: Ibaraki

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 308-0053

Page 2 03/30/04

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 23548

Phone:: (202) 737-6770

Fax:: (202) 737-6776

E-mail Address:: dcmail2@leydig.com

REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

Page 3 03/30/04

FOREIGN APPLICATION INFORMATION

Country:: Application Number:: Filing Date:: Priority Claimed

Japan 2003-434367 12/26/03 Yes

ASSIGNEE INFORMATION

Assignee name:: Semiconductor Leading Edge Technologies, Inc.

Street of mailing address:: 16-1 Onogawa

City of mailing address:: Tsukaba-shi

State or Province of

mailing address:: Ibaraki

Country of mailing

address:: Japan

Postal or Zip Code of

mailing address:: 305-0053

Page 4 03/30/04